

ABSTRACT

METHOD AND APPARATUS FOR PROCESSING  
AN ARRAY OF COMPONENTS

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The invention provides a method and apparatus for processing an array of electronic components. It involves providing mounting means to mount unsingulated components onto the mounting means, singulating the components to physically separate them, <sup>electrically</sup> and testing the singulated electronic components for defects whilst they are mounted on the mounting means, and without removal therefrom.

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(Figure 4)